



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Examiner: David Graybill Group Art Unit: 2827

In re PATENT APPLICATION of:

Applicants : Mitsuru KOMIYAMA

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SEMICONDUCTOR DEVICE

Attorney Ref.: F00ED0023-CA

Commissioner for Patents Washington, D.C. 20231

Sir:

INFORMATION DISCLOSURE STATEMENT

JUN 24 2002
TECHTER 2800
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This is an information disclosure statement submitted in compliance with the timing requirements of 37 C.F.R. §1.97(b)(1).

Attached is a copy of one U.S. patent publication. The publication is listed on the attached Form PTO-1449. Should any fee be needed, please charge it to our Account No. 50-0945 and advise us accordingly.

Consideration of the submitted documents is respectfully requested.

Respectfully submitted,

Junichi Mimura (Reg. No. 40351)

Oki America, Inc. 1101 14th Street N.W., Suite 555

Washington, D.C. 20005

(202) 452-6190

(202) 452-6148 fax

Customer No. 26071

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